



#### 40V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(on)</sub> Max	I <sub>D</sub> T <sub>C</sub> = +25°C
40V	6.5mΩ @ V <sub>GS</sub> = 10V	85A
	9.8mΩ @ V <sub>GS</sub> = 4.5V	70A

#### **Features**

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low R<sub>DS(on)</sub> Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH4007LPSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

## **Description and Applications**

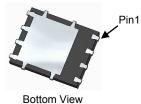
This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

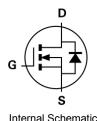
- Motor Controls
- DC-DC Converters
- Load Switches

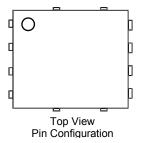
#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)









### Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH4007LPSQ-13	PowerDI5060-8	2.500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



#### PowerDI5060-8

☐ : = Manufacturer's Marking H4007LS = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 21 = 2021) WW = Week Code (01 to 53)

July 2021



### **Maximum Ratings** (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V <sub>DSS</sub>	40	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
II Continuous Drain Current Voc = 10V (Note 5)		T <sub>A</sub> = +25°C T <sub>A</sub> = +100°C	I <sub>D</sub>	15 11	А
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 6) Steady State		T <sub>C</sub> = +25°C T <sub>C</sub> = +100°C	I <sub>D</sub>	85 60	А
Maximum Continuous Body Diode Forward Current (Note 6)			I <sub>S</sub>	85	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I <sub>DM</sub>	340	Α
Avalanche Current, L = 0.1mH			I <sub>AS</sub>	20	А
Avalanche Energy, L = 0.1mH			E <sub>AS</sub>	20	mJ

# **Thermal Characteristics**

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	P <sub>D</sub>	2.7	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	55	°C/W
Total Power Dissipation (Note 6)	T <sub>C</sub> = +25°C	P <sub>D</sub>	83.3	W
Thermal Resistance, Junction to Case (Note 6)		ReJC	1.8	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +175	°C

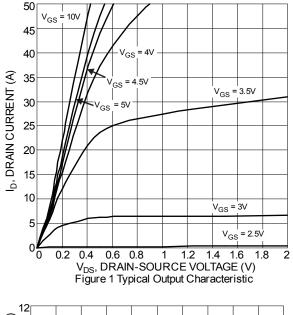
# Electrical Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

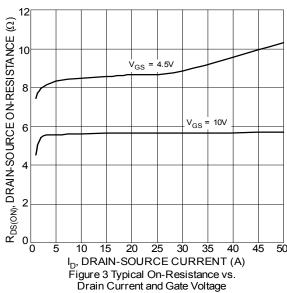
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_		1	μA	V <sub>DS</sub> = 32V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	I <sub>GSS</sub>	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)			•	•		•	
Gate Threshold Voltage	$V_{GS(th)}$	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	0	_	5.4	6.5	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A	
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>	_	8.4	9.8	11177	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 20A	
Diode Forward Voltage	$V_{SD}$	_	_	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	
DYNAMIC CHARACTERISTICS (Note 8)	•		•				
Input Capacitance	Ciss	_	1,895	_		V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V, f = 1MHz	
Output Capacitance	Coss	_	485	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	20.9	_			
Gate Resistance	Rg	0.1	0.62	1.8	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	12.4	_			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	29.1	_		V 201/ 1 201	
Gate-Source Charge	Q <sub>gs</sub>	_	5.9	_	nC	$V_{DS} = 30V, I_{D} = 20A$	
Gate-Drain Charge	$Q_{gd}$	_	3.5	_			
Turn-On Delay Time	t <sub>D(on)</sub>	_	5.4	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_{D} = 20A, R_{G} = 3\Omega$	
Turn-On Rise Time	$t_R$	_	4.5	_			
Turn-Off Delay Time	t <sub>D(off)</sub>	_	16.2	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	_	3.5	_			
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	30.6	_	ns	IF - 200 di/dt - 4000/us	
Body Diode Reverse Recovery Charge	$Q_{RR}$	_	28.1	_	nC	- IF = 20A, di/dt = 100A/μs	

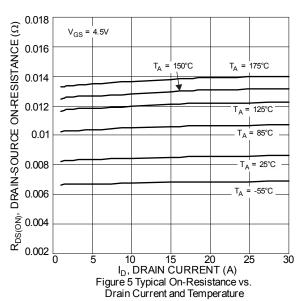
5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate. Notes:

6. Thermal resistance from junction to soldering point (on the exposed drain pad).7. Short duration pulse test used to minimize self-heating effect.8. Guaranteed by design. Not subject to product testing.

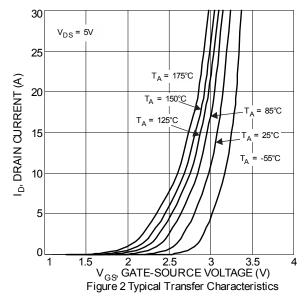


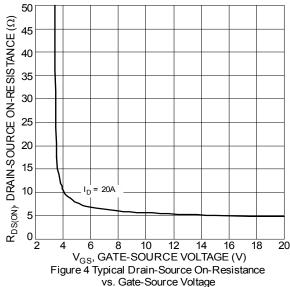


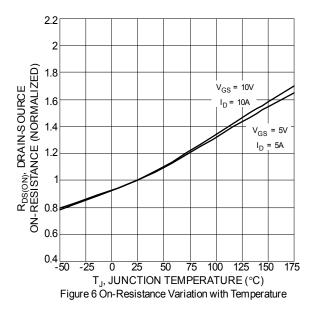




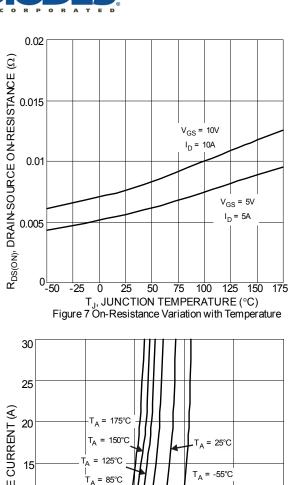
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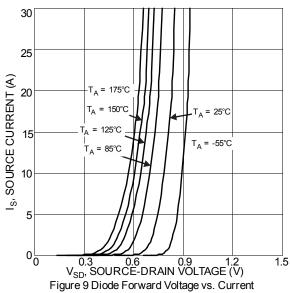


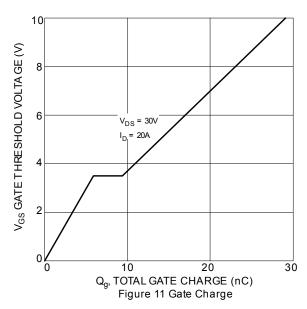


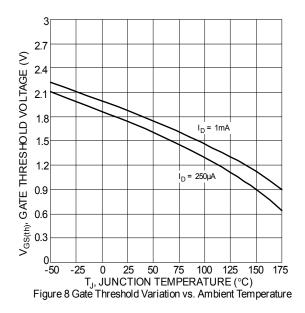


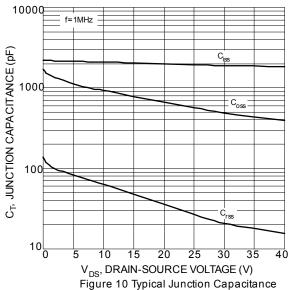


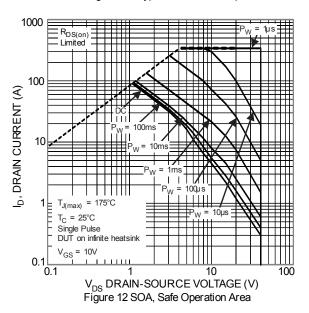




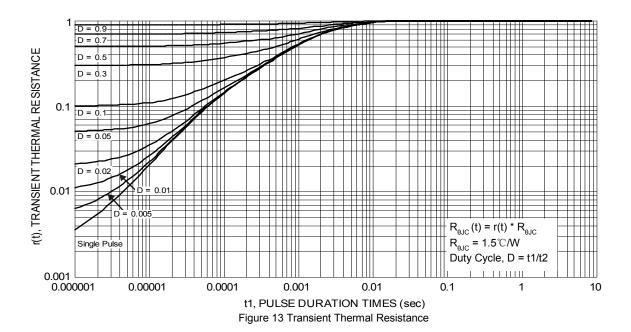










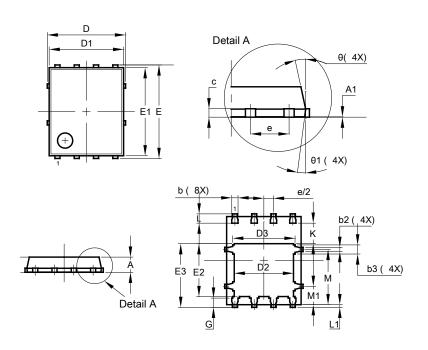




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8

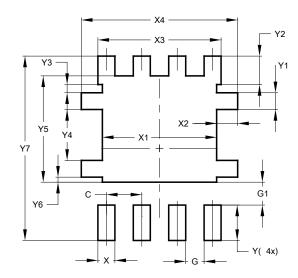


PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
<b>A</b> 1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	;	5.15 BSC	,		
D1	4.70 5.10 4.90				
D2	3.70	4.10	3.90		
D3	3.90 4.30 4.1				
Е	(	6.15 BSC	,		
E1	5.60	0 6.00 5			
E2	3.28 3.68 3.4				
E3	3.99 4.39 4.19				
е		1.27 BSC	;		
G	0.51	0.71	0.61		
K	0.51	_	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
M	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI5060-8



Dimensions	Value (in mm)			
С	1.270			
G	0.660			
G1	0.820			
X	0.610			
X1	4.100			
X2	0.755			
Х3	4.420			
X4	5.610			
Υ	1.270			
Y1	0.600			
Y2	1.020			
Y3	0.295			
Y4	1.825			
Y5	3.810			
Y6	0.180			
Y7	6.610			



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